PATMOS / VAR1 2013 SESSION OVERVIEW

MONDAY, Sept. 9th 2013		TUESDAY, Sept. 10th 2013		WEDNESDAY, Sept. 11th 2013	
8:00- 9:00 9:00- 9:15	Registration Welcome and Opening PATMOS Keynote 1:	8:30- 9:30	VARI Industrial Keynote: Philippe Flatresse & Robin Wilson, ST Microelectronics: System on Chip Variability Reduction, The UTBB FD- SOI Way: Technology and Design Solutions	8:30- 9:30	PATMOS Keynote 2: Bashir M. Al-Hashimi, University of Southampton, UK: Hardware reliability of embed- ded systems: are we there yet?
9:15- 10:15	Radu Marculescu, CMU: De- sign of Future Integrated Sys- tems: A Cyber-physical Sys- tems Approach	9:30- 9:50	Break	9:30- 9:50	Break
10:15- 10:30	Break PATMOS Session 1: Sub-Threshold Operation and Variability	9:50- 11:15	PATMOS Session 3: Microarchitectures and NoCs	9:50- 11:15	PATMOS Session 5: Simulation and Modeling
10:30- 12:45		11:15-	Break	11:15-	Break
		11:30- 12:45	PATMOS Session 4: Circuit Monitoring and Char- acterization	11:30- 12:45	PATMOS Session 6: Dynamic Voltage and Fre- quency Scaling
12:45- 14:00	Lunch	12:45- 14:00	Lunch	12:45- 14:00	Lunch
14:00- 15:30	PATMOS Special Session 1: Towards Cross Abstraction Level Power Closure	14:00- 15:30	VARI Session 1: Variability and Aging at De- vice and Circuit Level	14:00- 15:30	PATMOS Special Session 2: Low Power Design Methods in Emerging Technologies
15:30- 16:00	Break & Posters	15:30- 16:00	Break & Posters	15:30- 16:00	Break & Posters
16:00- 18:15	PATMOS Session 2: System-level Power and Thermal Management	16:00- 17:30	VARI Session 2: Sensors, Tools and design	16:00- 17:30	VARI Session 3: Variability and Aging Aware Design
				17:30	Closing Remarks

19:00 Social Event (Gastdozentenhaus)

PATMOS / VARI Program for Monday, Sept. 9th 2013

9:15-10:15 (Monday): PATMOS Keynote 1

Chair: Jörg Henkel, KIT

Title: Design of Future Integrated Systems: A Cyber-physical Systems Approach

Speaker: Radu Marculescu, Carnegie Mellon University, USA

- **Abstract:** In this talk, we address some fundamental issues related to the modeling and optimization of power and performance of next generation of integrated systems while taking a cyberphysical approach. As such, the focus of the design methodology is not only on establishing a reliable communication infrastructure between the computational elements, but also on including time, communication, and feedback-based control as intrinsic components of the programming model; this goal allows us generalize the classical computational paradigm such that more direct interaction between the cyber-system and physical world becomes possible. Starting from these overarching ideas, we argue that the complex requirements for highperformance and low-power design, as well as reliable and safe operation of future integrated systems call for a truly multidisciplinary approach which brings together concepts and techniques from real-time computing and signal processing, multiprocessor architecture and OS design, as well as distributed and self-organized control.
- **Bio:** Radu Marculescu is a Professor in the Dept. of Electrical and Computer Engineering at Carnegie Mellon University, USA. He received his Ph.D. in Electrical Engineering from the University of Southern California in 1998. He has received the Donald O. Pederson Best Paper Award from the IEEE Transactions of Computer-Aided Design of Integrated circuits and Systems in 2012, the Best Paper Award of IEEE Transactions on VLSI Systems in 2011 and 2005, as well as several best paper awards in major conferences in the area of design automation and multi-core design. Dr. Marculescu is currently an Associate Editor of IEEE Trans. on Computers, IEEE Trans. on Computer-Aided Design of Circuits and Integrated Systems, ACM Trans. on Embedded Computing Systems, and Elsevier Journal of Nano Communication Networks. He has been involved in organizing several international symposia, conferences, workshops, and tutorials, as well as guest editor of special issues in archival journals and magazines. His research focuses on design methodologies and software tools for embedded systems, cyber-physical systems, and biological systems. Radu Marculescu is an IEEE Fellow and an ACM Distinguished Speaker.

10:30-12:45 (Monday): PATMOS Session 1: Sub-Threshold Operation and

<u>Variability</u>

Chair: Lars Bauer, KIT

- **10:30** Maximizing Yield in Near-threshold Computing under the Presence of Process Variation Nathaniel Conos, Saro Meguerdichian, Sheng Wei, Miodrag Potkonjak, University of California, Los Angeles, USA
- **10:55** Ultra Low-Power Standard Cell Design using Planar Bulk CMOS in Subthreshold Operation Marc Pons, Jean-Luc Nagel, Daniel Séverac, Marc Morgan, Daniel Sigg, Pierre-François Rüedi, Christian Piguet, CSEM SA, Switzerland
- **11:20** Empirical Verification of Fault Models for FPGAs Operating in the Subcritical Voltage Region Alex Aa. Birklykke, Peter Koch, Ramjee Prasad, Aalborg University, Denmark Lars Alminde, GomSpace APS, Denmark Yannick Le Moullec, Aalborg University, Denmark
- **11:45** Variability analysis of Self-Timed SRAM robustness Frank Burns, Abdullah Baz, Delong Shang, Alex Yakovlev, School of Electrical and Electronic Engineering, Newcastle University, UK
- **12:10** A Variation Tolerant Architecture for Ultra Low Power Multi-processor Cluster Daniele Bortolotti, Davide Rossi, Andrea Bartolini, Luca Benini, University of Bologna, Italy
- 12:35 A learning tool MOSFET model A stepping-stone from the square-law model to BSIM4 (Short)

Kjell Jeppson, Chalmers University of Technology, Sweden

14:00-15:30 (Monday): PATMOS Special Session 1: Towards Cross Abstraction Level Power Closure

The Semantic of the Power Intent Format UPF: Consistent Power Modelling from System Level to Implementation

Juergen Karmann, Wolfgang Ecker, Infineon Technologies AG, Germany

Enabling Energy-Aware Design Decisions for Behavioural Descriptions Containing Black-Box IP-Components

Lars Kosmann, Daniel Lorenz, Axel Reimer, OFFIS, Germany Wolfgang Nebel, Universität Oldenburg, Germany

Power Contracts: A Formal Way Towards Power-Closure?! *Gregor Nitsche, Kim Gruettner, Wolfgang Nebel, OFFIS, Germany*

Formal System-on-Chip Verification: An Operation-Based Methodology and its Perspectives in Low Power Design

Joakim Urdahl, Shrinidhi Udupi, Dominik Stoffel, Wolfgang Kunz, University of Kaiserslautern, Germany

15:30-16:00 (Monday): Break and Poster session

Note: all 7 posters will be presented in all 3 poster sessions, i.e. 15:30-16:00 on Monday, Tuesday, and Wednesday.

Power Consumption Analysis Using Multi-View Modeling

Carlos Gomez, Université Nice-Sophia Antipolis / INRIA, France, Julien Deantoni, UNS - I3S - INRIA Sophia Antipolis Mediterranee, France, Frederic Mallet, Universite Nice Sophia-Antipolis, France

A Fully Standard-Cell Delay Measurement Circuit for Timing Variability Detection Alessandro Sassone, Massimo Petricca, Massimo Poncino and Enrico Macii, Politecnico di Torino, Italy

Automatic Implementation of Low-Complexity QC-LDPC Encoders

Georgios Tzimpragos, Athens Information Technology and National Technical University of Athens, Greece,

Christoforos Kachris, Athens Information Technology, Dimitrios Soudris, National Technical University of Athens, Greece, Ioannis Tomkos, Athens Information Technology, Greece

High Level Transforms to reduce Energy Consumption of Signal and Image Processing Operators

Haixiong Ye, ST Microelectronics, France, Lionel Lacassagne, Joel Falcou, Daniel Etiemble, LRI Univ. Paris-Sud, France, Laurent Cabaret, Ecole Centrale, France, Olivier Florente, ST Microelectronics, France

Peak Power Demand Analysis and Reduction by Using Battery Buffers for Monotonic Controllers

Waqaas Munawar, Jian-Jia Chen, Karlsruhe Institute of Technology, Germany

Design Methodology for Low-Power Embedded Microprocessors

Andrea Manuzzato, Fabio Campi, STMicroelectronics, Italy, Valentino Liberali, Universita' degli studi di Milano, Davide Pandini, STMicroelectronics, Italy

A Framework with Temperature-Aware Accuracy Levels for Battery Modeling from Datasheets

Massimo Petricca, Alberto Bocca, Donghwa Shin, Alberto Macii, Enrico Macii and Massimo Poncino, Politecnico di Torino, Italy

16:00-18:15 (Monday): PATMOS Session 2: System-level Power and Thermal

Management

Chair: Domenik Helms, OFFIS

16:00 Optimizing the Configuration and Control of a Novel Human-Powered Energy Harvesting System * Vishwa Goudar, Zhi Ben, Paul Brochy, Miodrag Potkoniak, Oibing Pei, University of California

Vishwa Goudar, Zhi Ren, Paul Brochu, Miodrag Potkonjak, Qibing Pei, University of California, Los Angeles, USA

- **16:25 Power saving policies for multipurpose WBAN** *Filippo Casamassima, Elisabetta Farella Luca Benini, University of Bologna, Italy*
- **16:50** Applying of Quality of Experience to System Optimisation Sascha Bischoff, Electronics and Computer Science, University of Southampton, UK, Andreas Hansson, ARM Ltd, UK, Bashir M. Al-Hashimi, Electronics and Computer Science, University of Southampton, UK
- **17:15 On-line Thermal Emulation: How to speed-up your thermal controller design** *Francesco Beneventi, Andrea Bartolini Luca Benini, University of Bologna, Italy*
- **17:40 Evaluating the Impact of Substrate on Power Integrity in Automotive Microcontrollers** Marco Cazzaniga, Universita' degli studi di Milano / STMicroelectronics, Italy, Patrice Joubert Doriol, STMicroelectronics, Italy, Emmanuel Blanc, Apache Design Inc., France Valentino Liberali, Universita' degli studi di Milano, Italy, Davide Pandini, STMicroelectronics, Italy
- **18:05** An Assessment of Software Lifecycle Energy (Short) Vasily Moshnyaga, Fukuoka University, Japan

^{*} Indicates a Bests Paper Candidate

PATMOS / VARI Program for Tuesday, Sept. 10th 2013

8:30-9:30 (Tuesday):

VARI Industrial Keynote

Chair: Francesc Moll, UPC

Title: System on Chip Variability Reduction, The UTBB FD-SOI Way: Technology and Design Solutions **Speakers:** Philippe Flatresse & Robin Wilson, ST Microelectronics, Crolles, France

- **Abstract:** Continued scaling of planar BULK-CMOS technologies enables density increase, but shows diminishing improvements in performance and power dissipation caused by variability and leakage current issues. Having identified that conventional planar bulk CMOS would not meet all the requirements of mobile and consumer multimedia System-on-Chip (SoC) ICs in the coming years, there is consensus in the industry that the next CMOS generations will be based on thin silicon film technologies. In this context, STMicroelectronics has chosen the 2D planar UTBB FD-SOI solution as mainstream CMOS technology, being a natural evolution of the conventional planar Bulk technology. UTBB FD-SOI offers the advantage to strongly reduce the impact of the two major detractors to the efficiency of traditional technology that are the transistor variability and the electrostatics. Thus, Planar UTBB FDSOI technology appears as the most attractive process against variability in SOCs at 28nm and beyond, making it a real differentiator in terms of design simplicity and flexibility. This talk will review how the variability is greatly improved thanks to UTBB FDSOI technology and the associated SOC design solutions.
- **Bio:** Philippe Flatresse received M.S. degree in Electrical Engineering in 1995 and PhD degree in Microelectronics in 1999 from Grenoble Institute of technology. In year 2000, he joined STMicroelectronics Central R&D to deploy the SOI digital design. His current research interests are the convergence of high performance and low standby power towards multimedia mobile applications thru disruptive digital and analog aware design. He has authored or coauthored more than 40 technical papers, and has filed more than 10 patents in advanced CMOS technologies.
- **Bio:** Robin WILSON (IEEE-M'91) received the B.Eng. degree in electrical engineering from the University College Cork, Cork, Ireland, in 1987. From 1987 to 1990, he worked within the semicustom development department of Plessey Semiconductors, UK. In 1990, he joined STMicroelectronics Central Research and Development Department, Crolles, France, where he is currently a design department manager of the Central CAD and Design Solutions Group in the area of high performance energy efficient design. His research interests include high performance design and silicon qualification in advanced CMOS processes.

9:50-11:15 (Tuesday): PATMOS Session 3: Microarchitectures and NoCs

Chair: Wolfgang Karl, KIT

- **9:50** Design of Variable Latency Adder Based On Present and Transitional States Prediction Xinghua Yang, Fei Qiao, Chang Liu, Huazhong Yang, Institute of Circuits and Systems, Dept. of Electronic, Engineering, Tsinghua National Laboratory for Information Science and Technology, Tsinghua University, China
- **10:15 SET Propagation in Micropipelines *** *Thomas Polzer, Andreas Steininger, Vienna University of Technology, Austria*
- **10:40** Evaluation of Hop Count Advantages of Network-Coded 2D-Mesh NoCs Michael Vonbun, Stefan Wallentowitz, Michael Feilen, Walter Stechele, Andreas Herkersdorf, Technische Universität München, Germany
- **11:05** Compiling for Performance and Power Efficiency (Short) Ewerton Lima, Brazil; Tiago Xavier, Anderson Faustino Da Silva, Linnyer Ruiz; State University of Maringá

<u>11:30-12:45 (Tuesday):</u> PATMOS Session 4: Circuit Monitoring and Characterization

Chair: Jian-Jia, Chen, KIT

11:30 Reliability Monitoring of Digital Circuits by in situ Timing Measurement Nasim Pour Aryan, Institute for Technical Electronics, Technische Universitaet Muenchen; Germany, Georg Georgakos, Infineon Technologies AG, Germany,

Doris Schmitt-Landsiedel, Institute for Technical Electronics, Technische Universitaet Muenchen, Germany

11:55 A Single Built-in Sensor to Check Pull-up and Pull-down CMOS Networks against Transient Faults

Rodrigo Possamai Bastos, TIMA Lab (CNRS - Grenoble INP - UJF), France, Frank Sill Torres, DEE, UFMG, Brazil Jean-Max Dutertre, Ecole des Mines de Saint-Etienne, France, Marie-Lise Flottes, Giorgio Di Natale, LIRMM, France, Bruno Rouzeyre, LIRMM. Univ. Montpellier 2, France

12:20 Metastability Characterization for Muller C-Elements * Thomas Polzer, Andreas Steininger, Vienna University of Technology, Austria

^{*} Indicates a Bests Paper Candidate

14:00-15:30 (Tuesday): VARI Session 1: Variability and Aging at Device and

<u>Circuit Level</u>

Chair: Nadine Azemar, LIRMM

14:00 Keynote: Time-dependent variability in advanced CMOS technologies: from nanoscale mechanisms to circuit level assessment

Speaker: Montserrat Nafria, UAB

Abstract: In ultra-scaled devices, because of the aging mechanisms that can be triggered during the device operation, the process-related variability turns into a time-dependent variability, so that the device electrical behavior must be described by statistically distributed parameters that evolve with time. Device aging depends on its particular operation in the IC (i.e., circuit topology, voltages, frequency, duty cycle, temperature...), so that it must be evaluated in a circuital context. Moreover, device time-dependent variability translates into shifts of the circuit parameters, leading to a loss of circuit performance and/or reliability. To establish the link between device aging and circuit operation/performance, statistical circuit simulation, which considers device aging (and also the initial variability), will be needed to capture the time-dependent device/circuit parameter variations. Therefore, a combination of Monte Carlo (to account for variability) and SPICE simulations (to consider the particular circuit configuration and device stress conditions) seems the most suitable approach. In this simulation methodology, the description of the device time-dependent variability is actually the clue for accurate simulations. Therefore, physics-based models of the aging phenomena, whose parameters account for the underlying fabrication technology and operation dependences, are required.

This work is focussed on the most important aging mechanisms in MOSFETs, i.e., Bias Temperature Instabilities (BTI), Channel Hot Carrier (CHC) degradation and Time Dependent Dielectric Breakdown (TDDB), using a multilevel approach, starting at the nanoscale and ending at circuit level. The atomic-scale origin of the different aging mechanisms will be discussed and their most important effects on the device electrical behaviour described, together with examples of physical models for the aging. Emphasis will be done on the electrical characterization of device aging for model parameter extraction. How the effects of process variability, BTI aging and TDDB effects at device level can be considered (with the aid of the physical models) during circuit simulation will be shown, by describing the main features of RELAB, an example of statistical circuit simulation tool. Some circuit simulation examples will show that such kind of tool can be used to identify the weakest devices in a circuit and to evaluate the circuit performance degradation, so that it could be used by circuit designers for circuit performance and reliability improvement, early during the design phase of the circuit.

Bio: Montserrat Nafria received the Ph.D. degree in Physics from the Universitat Autonoma de Barcelona, Spain, in 1993, where she is currently a Full Professor at the Department of Electronic Engineering. Her major research interests include CMOS device and circuit reliability. Currently, she is working on the characterization and modelling of the aging (BTI and channel hot carrier degradations) and variability of advanced MOS de-

vices. This is done from the nanoscale level, by studying the phenomena using Atomic Force Microscope-related techniques, up to circuit level, by developing device models for circuit simulators that account for their time-dependent variability. She is also interested in the characterization and modelling of Resistive-Switching devices. She is the author or coauthor of more than 200 research papers in scientific journals and conferences in all these fields.

- **14:30** Measurements of process variability in 40nm regular and non-regular layouts *J. Mauricio, F. Moll, S. Gómez, UPC*
- **14:50 Process variation compensation for PLL on FDSOI 28nm** A. Fonseca, E. De Foucauld, P. Lorenzini, G. Jaquemod, CEA-LETI, EPIB-UNS
- **15:10** Yield Estimation Model using a Lithography Hotspot Classifier S. Gómez, F. Moll, UPC

15:30-16:00 (Tuesday): Break and Poster session

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16:00-17:30 (Tuesday): VARI Session 2: Sensors, Tools and design

Chair: Marc Belleville, CEA LETI

16:00 Keynote: Statistical learning for test and control of analog/RF circuits

Speaker: Salvador Mir, TIMA

Abstract: The increasing variability of process parameters in nanometric CMOS integrated circuits is a major concern for design and test engineers. Circuit output parameters, including both specified performances and other test measurements, suffer also an increasing variability that affects device yield and test quality. Statistical techniques have been traditionally used for modeling parameter variability at the design stage and to estimate circuit yield. Today, statistical techniques aimed at modeling the complex relationships between circuit parameters are being proposed in the research community to address tasks such as the design of alternative built-in test techniques and the control of analog/RF circuits. In this talk, we will illustrate the use of probability density estimation, machine learning and parameter identification to assist design and test engineers for test and control tasks.

Bio: Salvador Mir has an Industrial Engineering (Electrical, 1987) degree from the Polytechnic University of Catalonia, Barcelona, Spain, and M.Sc. (1989) and Ph.D. (1993) degrees in Computer Science from the University of Manchester, UK. He is a Research Director of CNRS (Centre National de la Recherche Scientifique) at TIMA Laboratory in Grenoble, France. He is currently Vice-director of TIMA and he is leading the RMS (Reliable

Mixed-signal Systems) Group. He has published many papers in the field of mixed-signal/RF/MEMS test and he is co-author of two books on silicon Microsystems.

- **16:30** Characterization of MOSFET Local Systematic Variability in Presence of Statistical Variability O. Jonani, F. Piliado, G. Castaneda, A. Juge, STMicoelectronics, IMEP_LAHC
- **16:50** Temperature and Fast Voltage On-Chip Monitoring using Low-Cost Digital Sensors L. Vincent, P. Maurine, E. Baigné, S. Lesecq, J. Mottin, CEA-LETI, LIRMM
- **17:10** Robust Design of Microwave Circuits by Iterative Algorithm Using Orthogonal Arrays *T. Nakagawa, T. Kirikoshi, Mitsubishi Electric Corporation*

PATMOS / VARI Program for Wednesday, Sept. 11th 2013

8:30-9:30 (Wednesday): PATMOS Keynote 2

Chair: Alex Yakovlev, U. Newcastle

Title: Hardware reliability of embedded systems: are we there yet?

Speaker: Bashir M. Al-Hashimi, University of Southampton, UK

- Abstract: The last ten years has seen major academic research efforts to improve the reliability of embedded systems in the presence of various hardware faults. The talk will review the high-lights of this research and also report on some effective industrial practices in dependable hardware design. The aim is to motivate further focused research in system-level design approach and automation tools for reliable and energy-efficient design of future many-core embedded systems.
- **Bio:** Bashir M. Al-Hashimi holds the endowment ARM chair in Computer Engineering, school of Electronics and Computer Science (ECS), University of Southampton, UK. He is the director of the Pervasive Systems Centre for multidisciplinary research in Electronics and Computer Science, and he is a co-director of the ARM-ECS research centre. He serves as Dean of Research, Faculty of Physical Sciences and Engineering.

He has recently (2013) been elected Fellow of the Royal Academy of Engineering for his contribution to low-power design and test of mobile computing systems; fellows of the Academy comprise the UK most eminent and distinguished engineers and are recognised for their excellence in the science and practice of engineering. In 2009, he was elected fellow of the IEEE for significant contributions to design and test of low-power circuits and systems.

Prof. Al-Hashimi has published 300 papers, authored or co-authored 5 books, and graduated 32 PhD students. He served as Technical Programme chair and General Chair of DATE conference in 2009 and 2011, respectively.

Home Page: http://www.ecs.soton.ac.uk/~bmah

9:50-11:15 (Wednesday): PATMOS Session 5: Simulation and Modeling

Chair: Jörg Keller, Fernuniversität Hagen

- **9:50 Efficient Power Intent Validation Using Loosely-Timed Simulation Models** *Fabian Mischkalla, Wolfgang Mueller, University of Paderborn, Germany*
- 10:15 Modeling Noise Correlations for Model-Based Switch-Capacitor Sigma-Delta ADCs Design Optimization

Fu-Chuang Chen, Sheng Tzu-En, NCTU, Taiwan

10:40 An Efficient Eye-Diagram Determination Technique for Multi-Coupled Interconnect Lines Junghyun Lee, Yungseon Eo, Hanyang University, Korea

11:05 Accurate and Fast Power Annotated Simulation, Application to a Many-Core Architecture (Short)

Thomas Ducroux, Germain Haugou, Vincent Risson, STMicroelectronics, France, Pascal Vivet, CEA-Leti, France

11:30-12:45 (Wednesday): PATMOS Session 6: Dynamic Voltage and Frequency

Scaling

Chair: Jose Monteiro, TU Lisbon

11:30 Methodology for Power Mode Selection in FD-SOI circuits with DVFS and Dynamic Body Biasing

Yeter Akgul, Diego Puschini, Suzanne Lesecq, Edith Beigne, CEA/LETI/DACLE/LIALP, France, Pascal Benoit, Lionel Torres, LIRMM, France

- **11:55 Coupled Voltage and Frequency Control for DVFS Management** Mauricio Altieri, Warody Lombardi, CEA Grenoble, Minatec Campus, France, Diego Puschini, Suzanne Lesecq, CEA/LETI/DACLE/LIALP, France
- 12:20 Crown Scheduling: Energy-Efficient Resource Allocation, Mapping and Discrete Frequency Scaling for Collections of Malleable Streaming Tasks * Christoph Kessler, Nicolas Melot, Linköping University, Sweden, Patrick Eitschberger, Jörg Keller, Fernuniversität in Hagen, Germany

14:00-15:30 (Wednesday): PATMOS Special Session 2: Low Power Design Methods in Emerging Technologies

Power Modeling and Characterization of Graphene-Based Logic Gates *Massimo Poncino, Politecnico di Torino*

Dynamic Electrothermal Macromodeling Techniques for Thermal-Aware Design of Circuits and Systems

Alessandro Magnani, Vincenzo d'Alessandro, Niccolò Rinaldi, Massimiliano de Magistris, University of Napoli, Italy

Klaus Aufinger, Infineon Technologies AG, Germany

Power/Performance Implications of NoC Microarchitecture Decisions for Multicore Systems with Dynamic Frequency Scaling

Davide Zoni, Politecnico di Milano, Italy José Flich, Universitat Politècnica de València, Spain, William Fornaciari, Politecnico di Milano, Italy

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15:30-16:00 (Wednesday): Break and Poster session

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16:00-17:30 (Wednesday): VARI Session 3: Variability and Aging Aware Design

Chair: Antonio Rubio, UPC

- **16:00** Reconfiguration Proactive Techniques for Process and Aging Variation Aware Cache Design *P. Peyman, A. Rubio, UPC*
- **16:20** An Energy Efficient Pulse-Triggered Flip-Flop Robust to Local Variations in Ultra Low Voltage S. Bernard, A. Valentian, D. Bol, J. Legat, M. Belleville, CEA-LETI, ICTEAM
- **16:40** A Design for Yield approach for redundant FLASH ADC H.Y. Darweesh, G. Leger, A. Rueda, IMS-CSIC
- **17:00** Sizing for Static Noise Margins Revisited M. Tache, V. Beiu, W. Ibrahim, F. Khasbash, M. Alioto, United Arb Emirates University, Intel Labs